





May 2018

R&D PROPOSAL RD51 EXTENSION BEYOND 2018

Micropattern Gaseous Detectors RD51

EDITORS: S. Dalla Torre (INFN Trieste), E. Oliveri (CERN), L. Ropelewski (CERN), M. Titov (CEA Saclay)

Abstract

The RD51 Collaboration, in charge of the development and dissemination of MicroPattern Gaseous Detectors (MPGD) since 2008, proposes to extend its activity, after 2018, for a further five-year term. Since the RD51 initial years, the community of MPGD developers and users has grown considerably. It is reflected by the many MPGD-based applications in high energy and nuclear physics experiments as well as in other basic and applied-research fields. They rely on the parallel progress of detector concepts and associated technologies. The cultural, infrastructure and networking support offered by RD51 has been essential in this process. The rich portfolio of MPGD projects, under constant expansion, is accompanied by novel ideas on further developments and applications.

The proposed next term of RD51 activities aims at bringing a number of detector concepts to maturity, initiating new projects and continuing the support to the community. Among leading proposed projects are ultrafast, high-rate MPGDs; discharge-free, high-resolution imaging detectors with resistive elements and highgranularity integrated electronics; novel noble-liquid detector concepts, including electroluminescence in gas bubbles; studies of environment-friendly counting gases and long-term sealed-mode operation; optical-readout detectors with radiation-hard imagers for fundamental research experiments and radiography and more.

The proposed R&D program is also expected to enrich our basic knowledge in detector physics, to form a generation of young detector experts - paving the way to new detector concepts and applications. The vast R&D program requires acquiring additional, up-to-date knowhow in advanced technologies.

LHCC R&D Session May 2018

Leszek Ropelewski CERN EP DT GDD & RD51

The main objective is to advance MPGD technological development and associated electronic-readout systems, for applications in basic and applied research". http://rd51-public.web.cern.ch/rd51-public





- Access to the MPGD "know- how"
- Foster Industrial Production

- ~ 90 institutions
- ~ 500 members
- National and International Laboratories
- National Institutes and Universities

Micro Pattern Gaseous Detectors (MPGDs) and RD51 Collaboration

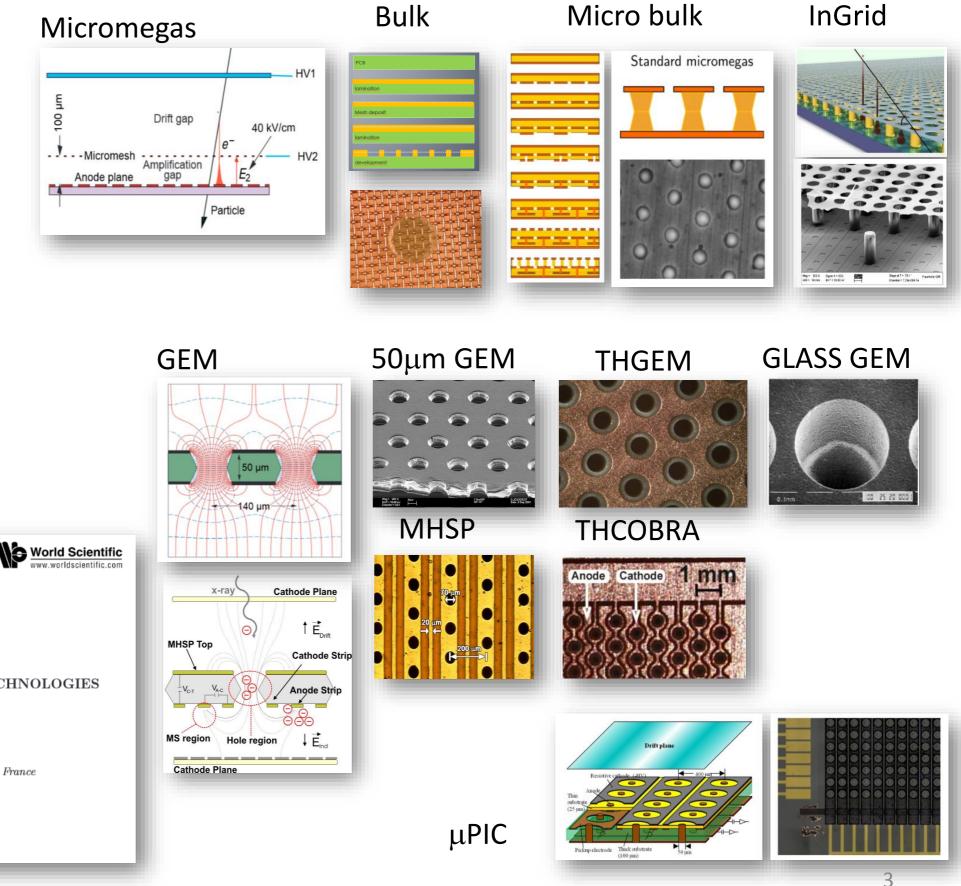
- High Rate Capability
- High Gain
- High Space Resolution
- Good Time Resolution
- Good Energy Resolution
- Excellent Radiation Hardness
- Good Ageing Properties
- Ion Backflow Reduction
- Photon Feedback Reduction
- Large Size
- Low Cost

Modern Physics Letters A Vol. 28, No. 13 (2013) 1340022 (25 pages) © World Scientific Publishing Company DOI: 10.1142/S0217732313400221

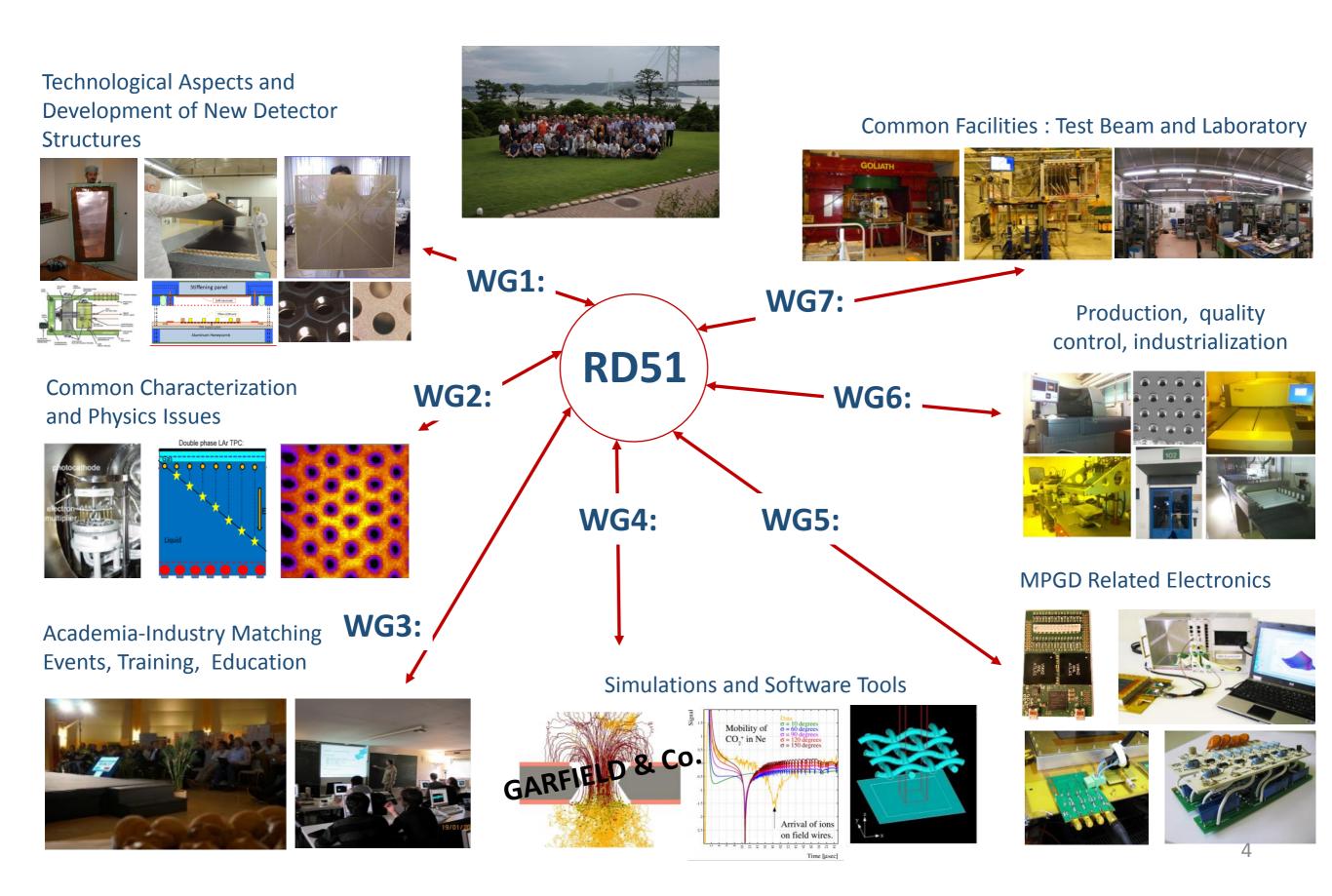
MICRO-PATTERN GASEOUS DETECTOR TECHNOLOGIES AND RD51 COLLABORATION

MAXIM TITOV CEA Saclay, DSM/IRFU/SPP, 91191 Gif sur Yvette, France maxim.titov@cea.fr

> LESZEK ROPELEWSKI CERN PH, CH-1211, Geneva 23, Switzerland leszek.ropelewski@cern.ch



RD51 (well consolidated) Working Groups



RD51 Achievements and Highlights

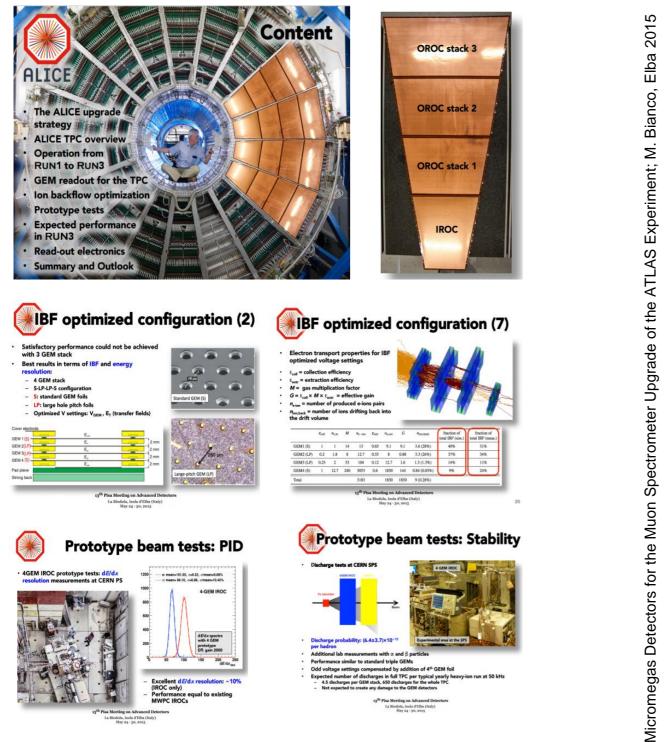
- Consolidation of the Collaboration and MPGD community integration (90 Institutes, ~500 members);
 Conferences, Meetings, Workshops, AIMEs, Schools, Lectures, Trainings
- Major progress in the MPGD technologies development in particular large area GEM (single mask), MicroMegas (resistive), THGEM; some picked up by experiments (including LHC upgrades);

ALICE, TPC read-out, ~ 500 m² of GEM foils ATLAS, small wheels, 1200 m² to be instrumented CMS, GE1/1 forward detectors, 250 m² of GEM foils COMPASS RICH, 4.5 m² to be instrumented, single photon detection

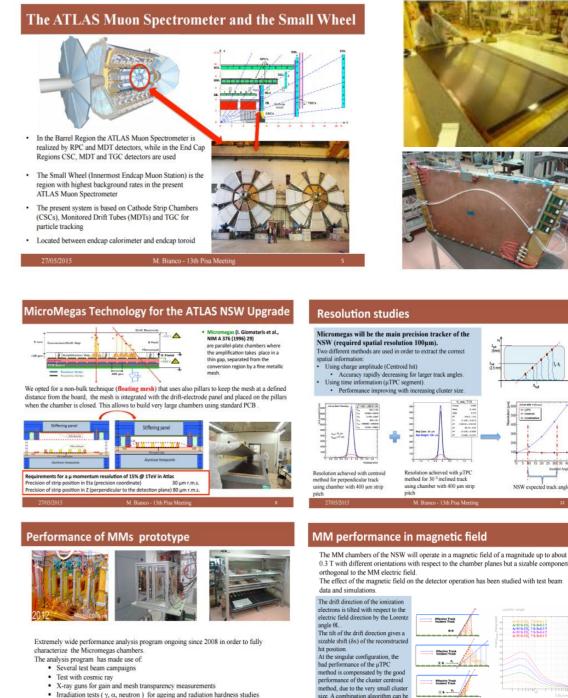
- Secured future of the MPGD technologies development through the EP DT MPT workshop upgrade and FP7 AIDA & AIDA2020 contribution;
- Contacts with industry for large volume production, MPGD industrialization and first industrial runs;
- Major improvement of the MPGD simulation software framework for small structures allowing first applications;
- Development of common, scalable readout electronics (SRS) (many developers and > 50 user groups);
 Production (PRISMA company and availability through CERN store); Industrialization (re-design of SRS in ATCA in EISYS); SRS Technology CERN spin-off, APV and VMM interfacing.
- Infrastructure for common RD51 test beam and lab facilities (>20 user groups)

Examples of CERN/LHC Upgrades

ALICE (GEM)



ATLAS NSW (mm)



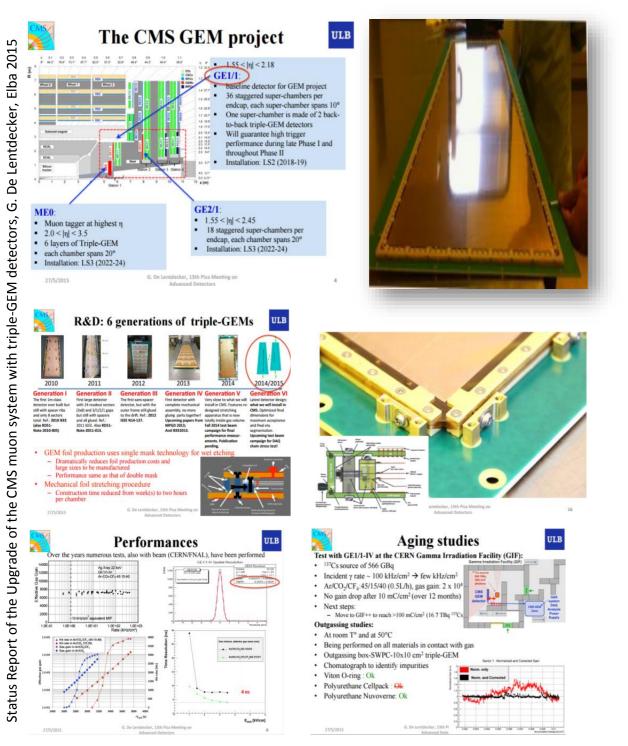
onlied to have a co

LHC Upgrades: Original R&D efforts emerged from RD51 activities.

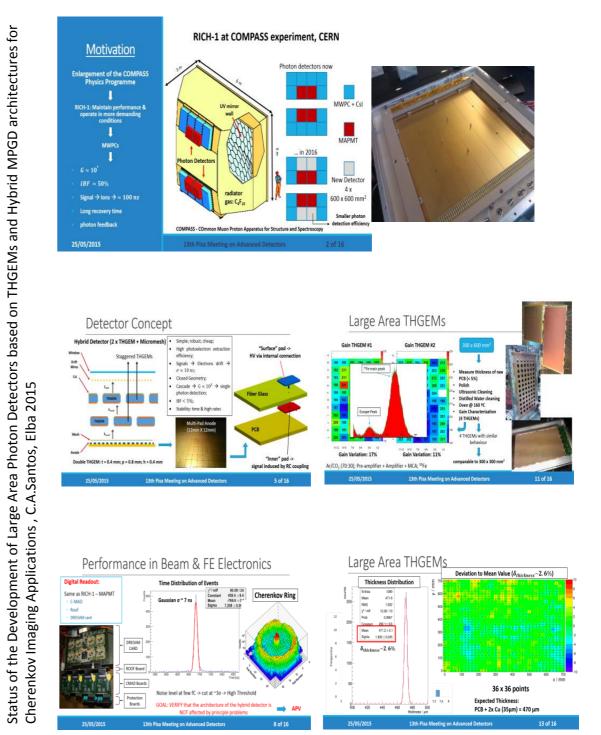
Today: production phase under the project effort, access to RD51 facilities (laboratory, test beam, workshops) and tools (simulation, electronics,...) to facilitate this particular phase

Examples of CERN/LHC Upgrades

CMS (GEM)



COMPASS RICH-1 (THGEM+MM)



LHC Upgrades: Original R&D efforts emerged from RD51 activities.

Today: production phase under the project effort, access to RD51 facilities (laboratory, test beam, 7 workshops) and tools (simulation, electronics,...) to facilitate this particular phase

Novel Technologies, New Ideas and Applications.

Calorimetry with MPGD

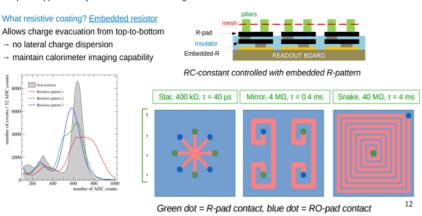
Resistive Micromegas for Sampling Calorimetry

M. Chefdeville*, Y. Karyotakis (IN2P3/LAPP, Annecy), T. Geralis (Demokritos, Athens), M. Titov (IRFU, Saclay)

Calorimetry at future collider will be based on Particle Flow (PF)

→ highly segmented calorimeters (small pads, many layers)

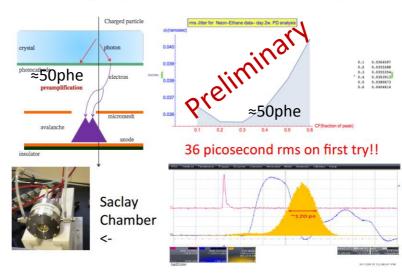
Micromegas meets most of the technical and performance requirements (m²-size prototypes)... ...but sparking might result from dense shower ionisation (e.g. nuclear recoils, EM shower core) → spark suppression by means of resistive coatings



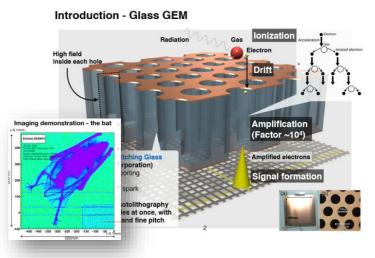
Fast Timing

MicroMegas based:

(initial tests March/April 2015) Ne-Ethane(10%)-200 micron drift+50micron Micro Bulk



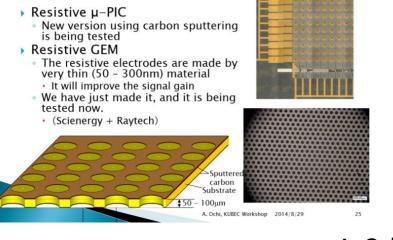
New Materials (Glass GEM)



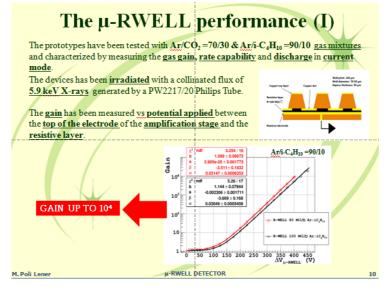
The Latest Results of Crystalized Glass GEM, Y. Mitsuia, RD51 miniweek (GDD/RD51 lab)

Resistive Material

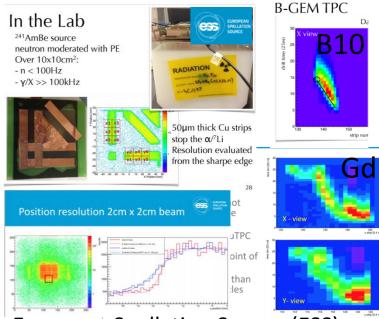
Other MPGD development using carbon sputtering



New Large Area Thin Detectors



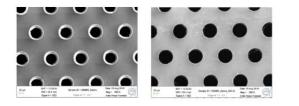
Neutrons Detection

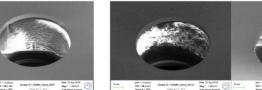


European Spallation Source (ESS)

R&D Support to the Projects and Experiments

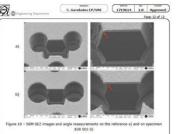
Effect of extreme operating conditions on the GEM detector components





"Reference" hole





Gating GEM

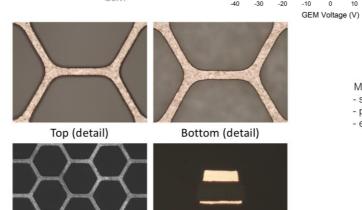
Ion back-flow at equal fields

Ion back-flow reaches maximum at approx. same voltage as for electron transparency

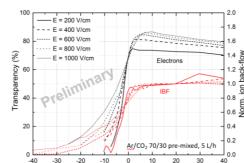
Higher voltages than for electrons to fully close gate

Very preliminary data with large error bars (not shown)! IBF normalized to $\Delta V_{GEM} = 20 V$

Top

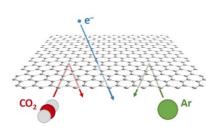


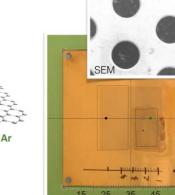
Cross-section (detail)



Graphene

Membrane opaque to ions and transparent to electrons: - solution of the ion back-flow in gaseous detectors - protective layer on photocathodes - enhancement of electron emission





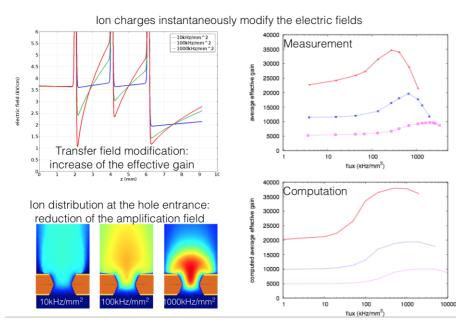
Discharge studies ALICE/CMS

~99% (suspended)

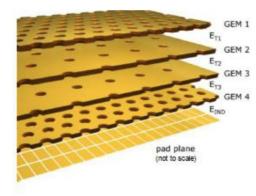
graphene tri-layer coverage

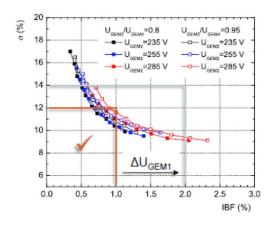
2.36hs

Ion density effects in multiGEM

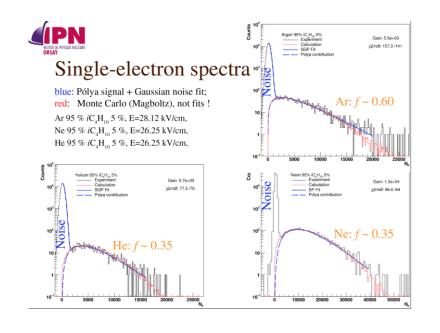








Modelling of Physics Processes and Software Tools



Mesh transparency

► Electron tracking requires improvement.

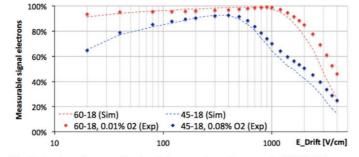
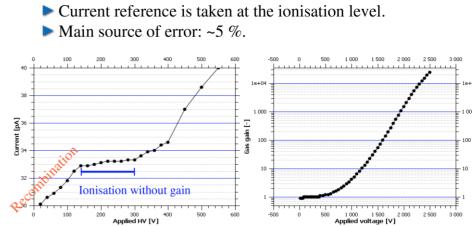


Fig. 5. Fraction of measurable signal electrons dependence on the drift field for two mesh geometries, experimental data (normalized signal strength) and simulation prediction (non-lost electrons after drift and mesh transition).

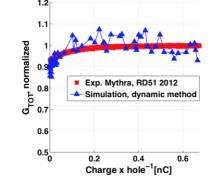
Fabian Kuger et al. 10.1016/j.nima.2015.11.011]





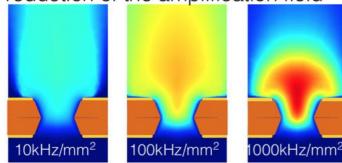
Charging-up of a GEM

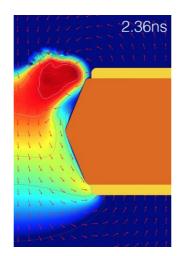
- Gain changes as a result of the charge deposits.
- Electron tracking to be refined.



[Pedro Correia et al. 10.1088/1748-0221/9/07/P07025]

Ion distribution at the hole entrance: reduction of the amplification field





Gas detector simulation: new areas

- Discharges and Resistive layers.
- ► Ion diffusion.
- ▶ Refinement of ionisation esp. at low energy.
- Integration of boundary element methods.

The RD51 Scalable Readout System (SRS) Electronics and Instruments for Detectors

MPGD-stand

Sparc protect

PCB with ENIG surface for bonding pads.

embeded via

SRS frontend Hybrids

Readout and power via HDMI Micro

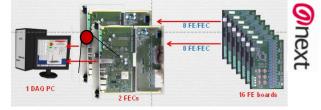
Master-Slave cable

Chamber grounding via MMCX plugs

nector

SRS & APV25 FE chip

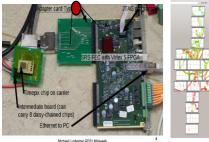
Worldwide use in the RD51 community (>2000 hybrids) SRS+SiPM (NEXT TPC)

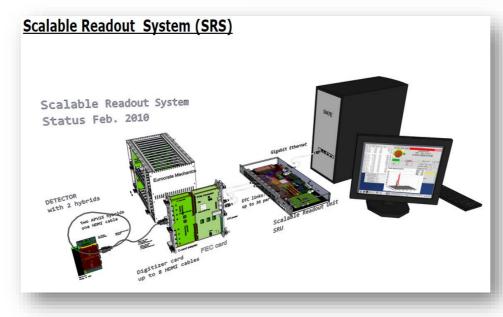


SRS-FEC+TOTEM DAQ



SRS+Timepix (LC-TPC) – Bonn/Desy





SRS: Different System SRS for R&D on Detectors





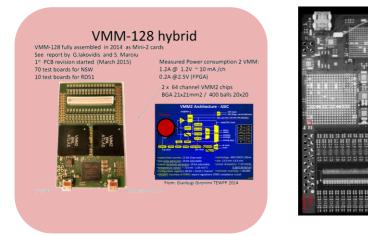




SRS for experiments (ATCA) LHC experiments: from detector to counting room r<1m present r<100m r<200m r>200m r>2

pretic fields up 2T
Magnetic fields < 0.5 T
environment
UC calole (max)
CC ca

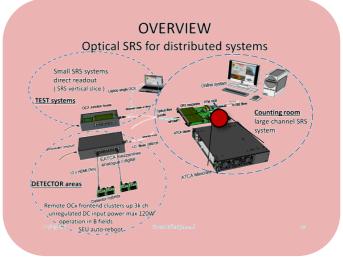
Very appealing for the future: VMM (NSW ATLAS FE chip)



Baseline solution for RD51 SRS community.

Interest and support from ESS (European Spallation Source) and ALICE FOCAL

SRS for spatially distributed system (optical SRS)



EP-DT-DD GDD Laboratory available for the RD51 Collaboration Members



Permanent installations (Today): ALICE, ATLAS, ESS CMS moved roughly two years ago to TIFF, access to the lab for specific measurements More than 15/20 groups per year coming to perform measurements

Clean Rooms

Mechanical and Electronic Workshop

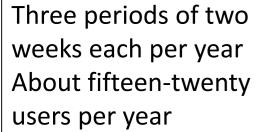


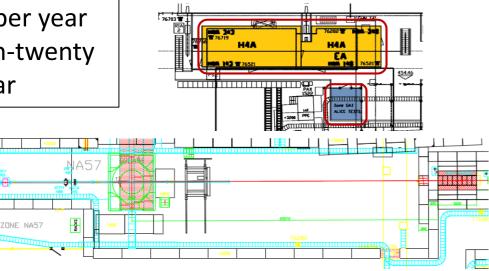




Technical support MPGD Detectors Gas system and services Readout electronics (std and custom RD51 SRS&APV) Radioactive Sources Interface with CERN services (RP, gas, metrology, irradiation facilities,...)

Semi Permanent Test Beam Facility

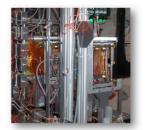




Rd51 trackers

 Triple GEM Tracker • XY strips readout, 400um pitch • 10x10 cm² · APV (VFAT2) • DAQ&FE: SRS/APV (TURBO/VFAT)

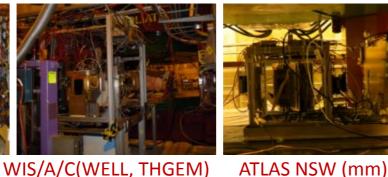
 Resistive µmegas tracker • XY strips readout, 250um pitch • 9x9 cm² · APV · DAQ&FE: SRS/APV





Examples of the test beam user teams

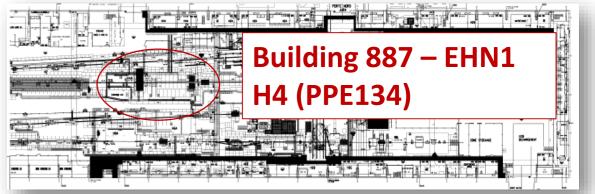




Slow Control System (HV/LV) A A Soco GALMA



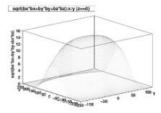
in the SPS Extraction Line



Goliath Magnet \rightarrow Ship?



Alfonsi (CERN) RD51-WG7 2009-VI 28/04/2009



Field map realized during NA57 exper file decoded by Frascati group

Power: about 2MW Maximum field: 1.4T Gap volume: around 8 m³

A warm and special thanks to the SPS, the North Area Facility and to all the people that supports our installations

9/23/2014

1st User meeting



BESS III & SHIP (GEM)





LAPP/DEM/IRFU(mm) ALICE TPC (GEM and mm)

Technology: MPGD Production and Development @ CERN

MPGD Projects....

- SBS tracker
 ALICE TPC upgrade
 CMS muon
 ATLAS NSW muon
 COMPASS pixel Micromegas
 BESIII
 KLOE
 SOLID
 CLAS 12
 LSBB (geoscience)
 Prad
 CBM
 ASACUSA
- GEM 600mm x 500mm GEM 600mm x 400mm GEM 1.2m x 450mm Micromegas 2m x 1m GEM & Micromegas 500mm x 500mm GEM 600mm x 400mm GEM 700mm x 400mm GEM 1.1m x 400mm Micromegas 500mm x 500mm Micromegas 1m x 500mm GEM 1.5m x 55cm GEM 1m x 450mm Micromegas

•Most of them are still at the R&D phase but some are already in production:

ATLAS NSW
SBS Tracker
ALICE TPC upgrade
COMPASS pixel Micromegas
BESIII
CLAS 12
CMS
450 GEM

100 GEMs 350 GEMs 20 GEM + Micromegas 15 GEM 30 Micromegas 450 GEM



New Capabilities....

UV exposure unit limited to $2m \ge 0.6m$ $\rightarrow 2.2m \ge 1.4m$ ----



Resist developer limited to $0.6 \text{m width} \rightarrow 1.2 \text{m}$ Resist stripper " Copper etcher " Dryer "

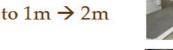


GEM electro etch limited to $1m \rightarrow 2m$





GEM polyimide etch limited to $1m \rightarrow 2m$

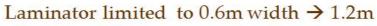




Ovens limited to $1.5 \text{m x} 0.6 \text{m} \rightarrow 2.2 \text{m x} 1.4 \text{m}$



Laminator lim





Installation of the new infrastructure (to fabricate 2x1m² Bulk MM & 2x0.5m² GEM) COMPLETED



Construction of the new workshop's building:

Start : beginning of 2012 End: end of 2017



CERN Building 107 Basis of Design 14

RD51 Future R&D Environment

R&D Environment

Expertise, infrastructure and tools

People - core service; generic and support R&D group

Minimum infrastructure - R&D lab and test beam facilities

Community:

open information and experience exchange;

organization of the conferences, meetings, workshops, schools, lectures, trainings, AIMEs

contribution to the development, maintenance and user support

of the infrastructure, electronics and software tools

education of the new generation of instrumental physicists

Interdisciplinary CERN wide Instrumentation R&D Infrastructure

Alternatively **access** to CERN and external facilities :

MPT Thin Film Deposition Mechanics, designer office, 3D printing Metrology

Nano Lab (EPFL) Industry (strategic partnership) and TT

Generic R&D support grants to explore innovative ideas

Detector R&D dedicated **electronics** support

Detector physics and simulation software tools support

Diversified Resources

CERN

Collaborating institutions and projects contributions Industry EU projects Project synergies

Project Oriented R&D

R&D support to the projects and experiments

Access to the R&D environment

MPGD Generic R&D

Moving performance to the limits and developing new concepts and applications

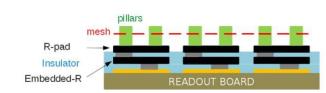
Flagship technologies – Resistive materials and architectures

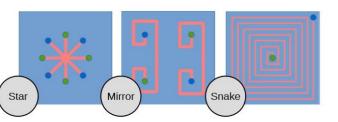
Pad boards

10X10 matrix of 1x1 cm2 pads Routing on the outside to a 'Gassiplex' connector (96 channels)

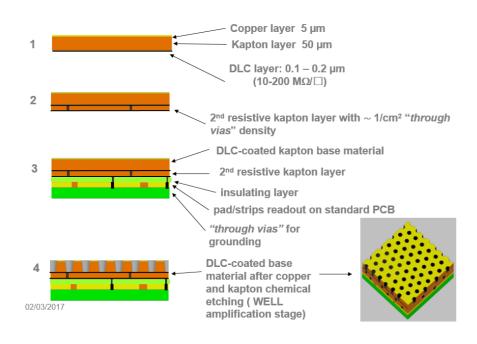
R-structures and Bulk-Micromegas

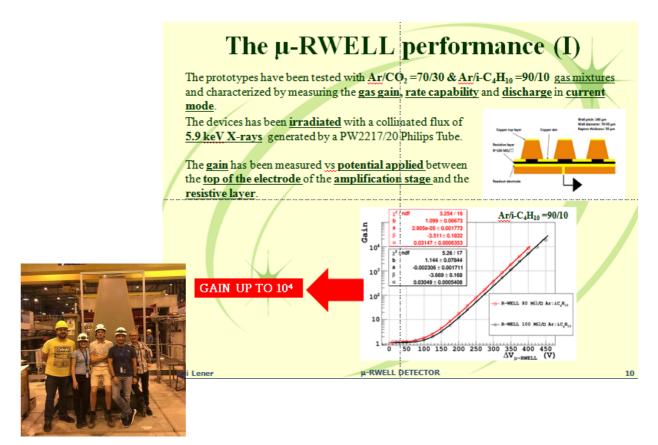
Serigraphy and photolithography at CERN MPGD workshop





The High Rate scheme (LHCb)





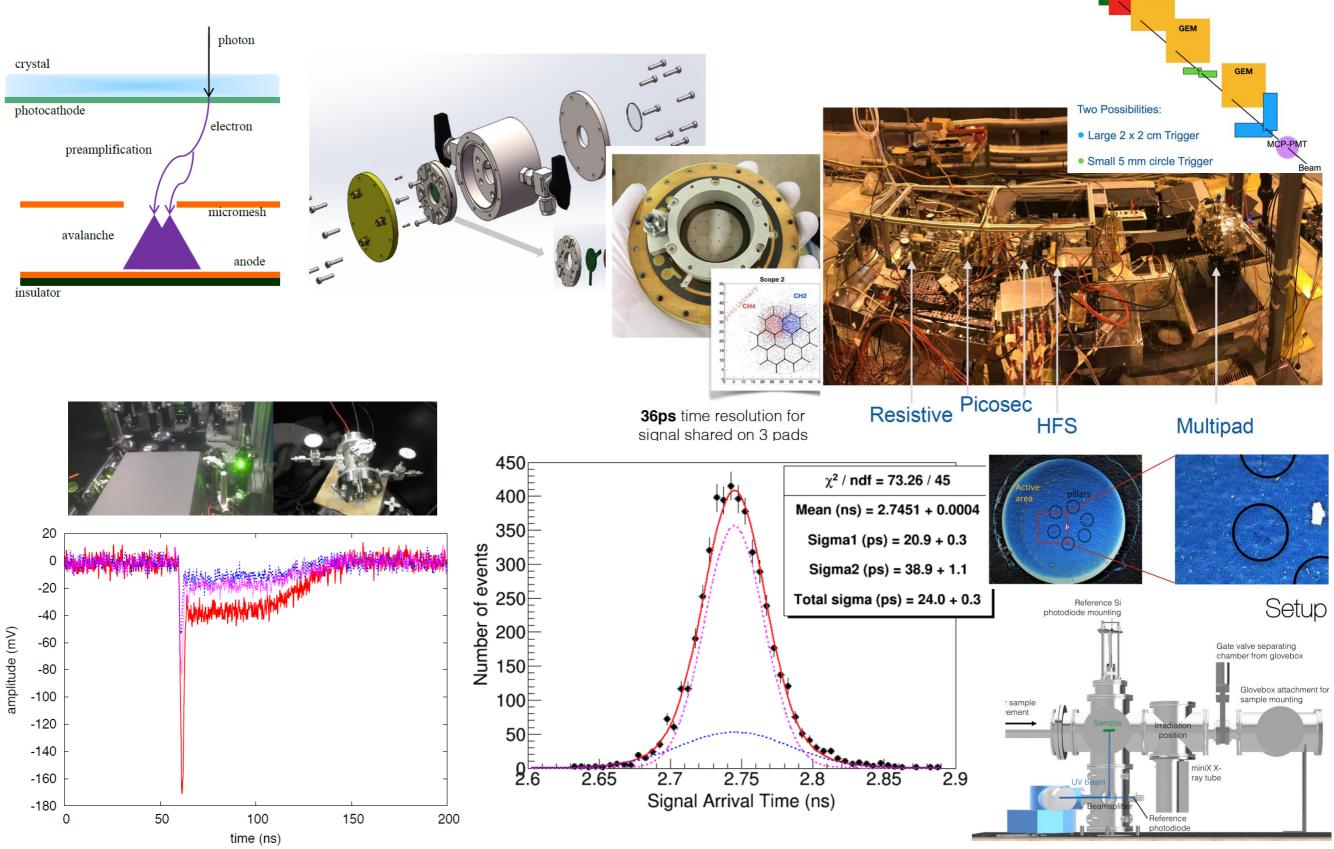
Resistive electrodes with DLC Liftoff process with sputtering Photo resist (reverse pattern of On beginning of 2013, we surface strips) have developed resistive electrodes by DLC Substrate (polyimide) Initially, it was developed for ATLAS MM resistive foils Fine micro-patterning Carbon (um order) available sputtering \rightarrow applying it for u-PIC electrodes Substrate (polyimide) Developing the resists

A.Ochi RD51 mini-week 2017/12/15

Substrate (polyimide)

4

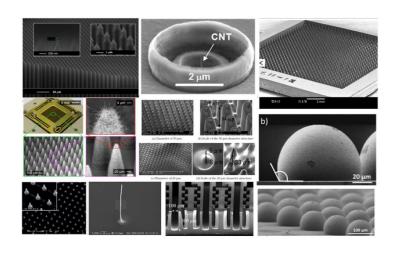
RD51 Future Flagship technologies – Fast and precise timing

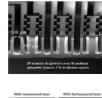


GEN

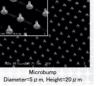
Flagship technologies – New materials and technologies

Prototyping: new techniques as 3D/Ink-Jet printing, etching and laser to create novel structures will spee ' up and enlarge the detector prototyping capabilities.

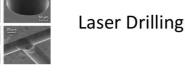






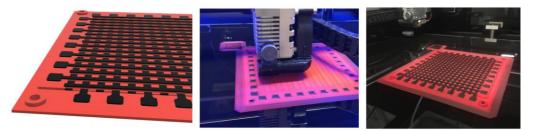


DRIE Plasma



Super InkJet Printer





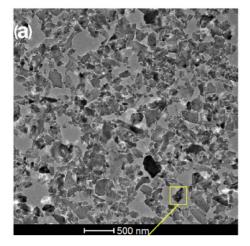
2 layers of strips separated by insulating material

Bottom strips: 3mm wide at 6mm pitch Top strips: 2mm wide at 6mm pitch

Signal feedthrough to the back for contacting

18kΩ resistance along track $2-7k\Omega$ resistance through contact feedthrough

Innovative photocathodes by ND powder



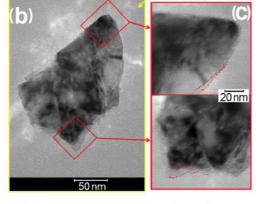
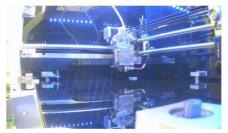


FIG. 2. TEM images of the (a) as-received nanodiamond (ND) particles, " a single ND particle and (c) details of the single ND particle.

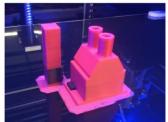
Highly efficient and stable ultraviolet photocathode based on nanodiamond particles L. Velardi, A. Valentini, and G. Cicala, Appl. Phys. Lett.108, 083503 (2016)

Ionisation chamber

Printed overnight with 0.1mm layer height and slow speed for high surface quality







Timelapse of printing

IR-image during printing

Finished print

Flagship technologies – Hybrid detectors

The "QUAD"

InGrid & TimePix, the ultimate gaseous TPC (H. Van Der Graaf)

CAST

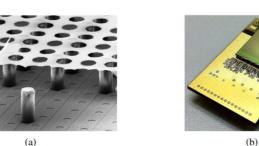




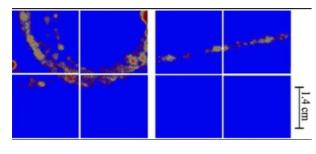
Figure 1: SEM image of an InGrid structure on top of a Timepix ASIC (a), taken from [13]. In the SEM image parts of the mesh have been removed to show the good alignment between pixels and mesh holes. And a bare Timepix ASIC on a carrier board (b).

https://cds.cern.ch/record/2025932/files/PoS(TIPP2014)060.pdfT

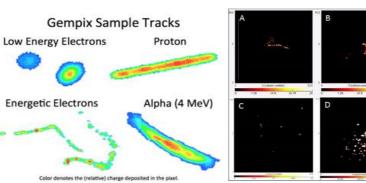
256 x 256 pixels, 55 x 55 μm pitch, about 1.4x1.4 cm2 sensitive area

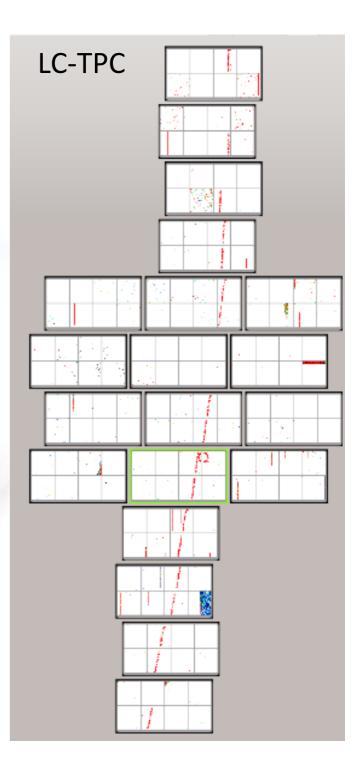
F. Hartjes, https://agenda.linearcollider.org/event/7795/contributions/40334/at tachments/32507/49403/QUAD_development.pdf

A large TPC prototype for a linear collider detector P. Schade, J. Kaminski, NIMA, 628, 1, 1 February 2011, Pages 128-132



GEMPIX (F. Murtas et al.)

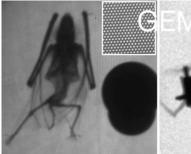




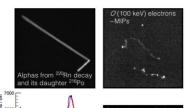
J. Kaminski,

https://indico.cern.ch/event/391665/contributions/182 7282/attachments/1230061/1802690/GridPix.pdf

Flagship technologies – Hybrid detectors



Radiography of a bat and closeup of the GEM holes



Radiography of a Freeze-frame of an X-ray crushed cup with pens and movie of a flying drone its 3D tomographic reconstruction

O DIIO

Single X-rays from 55Fe

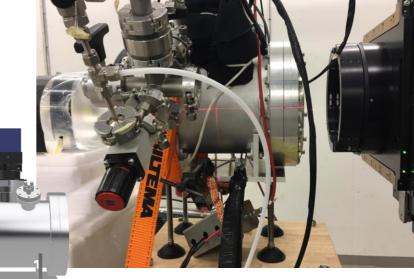
2.5 collected light (a.u.)

and the energy spectrum extracted from the images adout

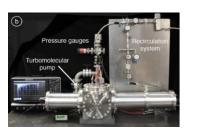
Visible picture of a *painting* and its X-ray fluorescence image. Different colours refer to different materials (energy resolved)



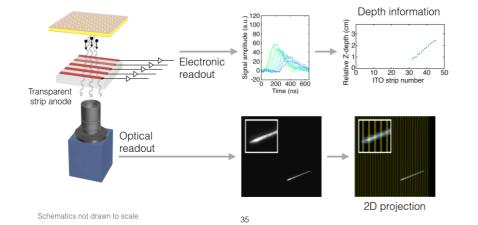
Optically read out MMs (2018)



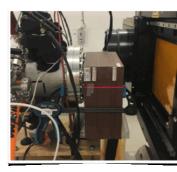
Depth dose curve



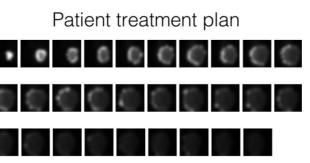
Combined electronic and optical readout



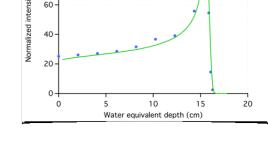


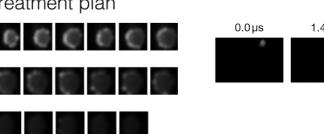


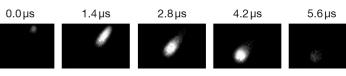
Integrated CCD images eference measuremen 80 (% 60 40 20 10 15 20 0 -5 Water equivalent depth (cm)





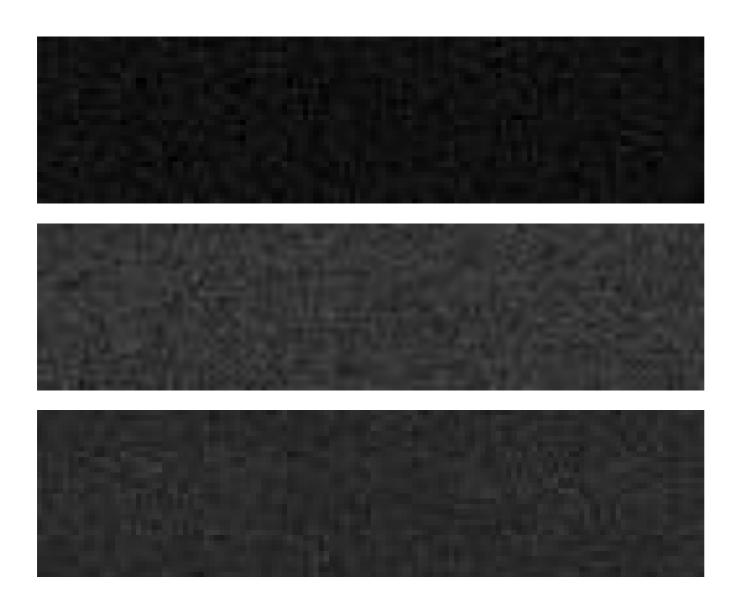








Phantom High Speed Camera - oTPC α tracks almost SF



Phantom v2512



- 1 megapixel CMOS sensor
- 12 bit depth
- 25 kfps at full resolution
- 1 Mfps at 128x32
- ISO 100,000 sensitivity

Resolution	FPS
1280 x 800	25,700
1280 x 720	28,500
1024 x 512	47,400
640 x 480	70,100
512 x 384	99,800
256 x 256	206,300
256 x 128	380,100
128 x 64	783,100
128 x 32	1,000,000
128 x 16	1,000,000

RD51 Request

RD51 proposes to extend its activities for further five-year term.

RD51 requests limited support from CERN facilities at existing level:

• access to the Gaseous Detectors Development (GDD) lab space, infrastructure and maintenance support;

• office space and administrative support;

• maintenance of the semi-permanent setup at the SPS H4 test beam line and, correspondingly, access to the beams over several time periods for a total of six weeks per year;

- continuation of the collaborative access to the:
- the Micro Pattern Technology Workshop (EP-DT-EF MPT)
- the Thin Film and Glass Laboratory (EP-DT-EF TFG);
- access to other CERN technical facilities, in particular:
- Bonding Laboratory (EP-DT-DD)
- Electronics Assembly Workshop (TS-DEM-WS)
- Materials, Metrology & Non Destructive Testing (EN-MME-MM)
- Surface treatment, coating and chemical analysis (TE-VSC)
- the central computing resources for MPGD simulations.

LARGE HADRON COLLIDER COMMITTEE

Minutes of the one-hundredth-and-thirty-fourth meeting held on Wednesday and Thursday, 30-31 May 2018

RD51: Development of Micro-Pattern Gas Detectors Technologies

• RD51 is an established collaboration with the aim to develop Micro-Pattern Gas Detector (MPGD) technologies, to support experiments using this technology, and to disseminate the technology within particle physics and in other fields. The collaboration is well organized into seven working groups covering activities from new detector structures and electronics, to modelling, test facility management and industrialization.

• The collaboration has achieved major progress in MPGD technologies, some of which have already been picked up by experiments: ALICE TPC readout, ATLAS NSW, CMS GE1/1 forward detectors, Compass RHICH detector. The committee congratulated the collaboration for its progress since the last review session.

• A prolongation request for 5 years has been submitted to the present session of the LHCC. Apart from the support of the ongoing projects, the proposal included plans to explore new materials and technologies to achieve ever better resolution in space and time and open the door to new use cases both in HEP and elsewhere.

• The LHCC recommends granting RD51 the 5-year extension requested, including CERN support at the level currently provided. Progress will be reviewed every year by the LHCC. The LHCC considers the working mode of RD51, with a small but focused core team and corresponding infrastructure at CERN, attracting contributions and bright ideas to be explored from collaborators around the world, to be an excellent setup. The LHCC notes that the CERN contribution to RD51 as listed in the proposal is crucial for the collaboration, and strongly encourages CERN to maintain its support of RD51.